

D6KB05 THRU D6KB10

Glass Passivated Bridge Rectifiers 玻璃钝化整流桥

Reverse Voltage - 50 to 1000 Volts 反向电压 50-1000V Forward Current - 6.0 Amperes 正向电流 6.0A

Features 特征

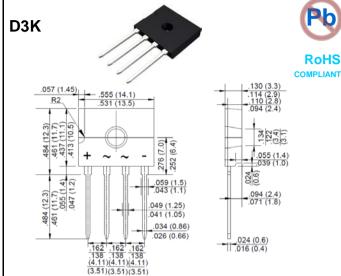
- Glass passivated chip 玻璃钝化芯片
- Low forward voltage drop 正向压降低
- Ideal for printed circuit board 适用于印刷电路板中
- High surge current capability 高的浪涌能力

Mechanical Data 外观信息

- Polarity: Symbol marked on body 极性:标志在产品的本体上
- Mounting position: Any 安装位置: 任何位置

Applications 应用

- General purpose use in AC/DC bridge full wave rectification, for SMPS, lighting ballaster, adapter, etc.
- 一般应用于交流/直流桥式全波整流,如:开关电源,照明镇流器、适配器等。



Package Outline Dimensions in Inches (Millimeters)

封装外观尺寸单位英寸(毫米)

Maximum Ratings and Electrical Characteristics 最大额定值及电气特性

Rating at 25℃ ambient temperature unless otherwise specified. 环境温度25℃,除非特别说明。 Single phase, half wave, 60Hz, resistive or inductive load. 单相半波, 60Hz,阻性或感性负载。 For capacitive load, derate current by 20%. 对于电容性负载,降低20%的额定电流。

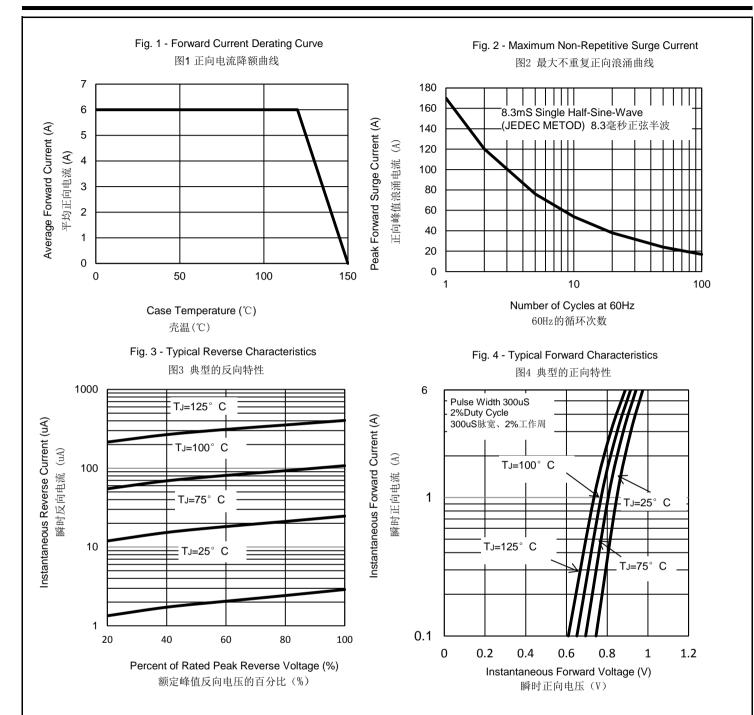
Characteristics 特性	Symbol 符号	D6KB05	D6KB1	D6KB2	D6KB4	D6KB6	D6KB8	D6KB10	Unit 单位
Maximum Repetitive Peak Reverse Voltage	Vrrm	50	100	200	400	600	800	1000	٧
最大重复峰值反向电压	VKKIVI								
Maximum RMS Voltage 最大有效反向电压	VRMS	35	70	140	280	420	560	700	V
Maximum DC Blocking Voltage 最大直流阻断电压	VDC	50	100	200	400	600	800	1000	V
Maximum Average Forward Rectified Current @Tc=120 ℃(with heatsink) 最大正向平均整流电流	I(AV)	6							Α
Peak Forward Surge Current, 8.3mS Single Half Sine-Wave, Superimposed on Rated Load (JEDEC Method) 8.3mS单一正弦半波叠加在额定负载上的浪涌能力(JEDEC方法)	IFSM	170							Α
I ² t Rating for Fusing (t<8.3mS) 熔断额定值 (t<8.3mS)	l ² t	119.9						A^2s	
Peak Forward Voltage per Diode at 3.0A DC 单个二极管在3.0A电流下的正向峰值电压	VF	1.0						V	
Typical Thermal Resistance to Ambient 结到环境的典型热阻值	RθJA	45							
Typical Thermal Resistance to case 结到壳的典型热阻值	Rejc	6							°C/W
Typical Thermal Resistance to lead 结到引线的典型热阻值	Røjl	9							
Maximum DC Reverse Current at Rated @TJ=25°C		5.0							
DC Blocking Voltage per Diode @TJ=125℃	IR	500							μΑ
单个二极管在额定直流电压下的最大反向直流电流									
Operating Junction Temperature Range 结温工作范围	TJ	-55 to +150							$^{\circ}$
Storage Temperature Range 储存温度范围	Tstg	-55 to +150							$^{\circ}$

Note: The typical data above is for reference only(典型值仅供参考).

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